

Amendments to the Claims

This listing of claims will replace all prior versions and listings of claims in the application.

1. (Original) A magnetic wafer seal comprising:
 - a. a flexible magnet, said magnet having an upper surface, a lower surface, a thickness between said upper surface and said lower surface, a line of weakness extending at least partially across said upper surface, and a shape; and
 - b. an adhesive layer affixed to said lower surface;
 - c. where said line of weakness extends at least partially through said thickness towards said lower surface, said flexible magnet being foldable along said line of weakness.
2. (Original) The magnetic wafer seal as recited in Claim 1, where said line of weakness is comprised of a multiplicity of perforations, and where said multiplicity of perforations are separated by a spacing between adjacent perforations of said multiplicity of perforations.
3. (Currently amended) A magnetic wafer seal comprising:
 - a. a flexible magnet, said magnet having an upper surface, a lower surface, a thickness between said upper surface and said lower surface, a line of weakness extending at least partially across said upper surface, and a shape; and
 - b. an adhesive layer affixed to said lower surface;
 - c. where said line of weakness extends at least partially through said thickness towards said lower surface, said flexible magnet being foldable along said line of weakness, where said line of weakness is comprised of a multiplicity of perforations, and where said multiplicity of perforations are separated by a spacing between adjacent perforations of said multiplicity of perforations;
 - d. The magnetic wafer seal as recited in Claim 2, where said spacing comprises a first spacing and a second spacing, said first spacing having a shorter length than said second spacing.

4. (Original) The magnetic wafer seal as recited in Claim 3, where said line of weakness is further comprised of at least two areas of weakness, said at least two areas of weakness each comprised of a multiplicity of perforations separated by a first spacing between adjacent perforations of said multiplicity of perforations, where adjacent said at least two areas of weakness are separated by a second spacing therebetween.
5. (Original) The magnetic wafer seal as recited in Claim 4, where said line of weakness extends substantially across said upper surface.
6. (Original) The magnetic wafer seal as recited in Claim 5, where said multiplicity of perforations extend fully through said thickness to said lower surface.
7. (Original) The magnetic wafer seal as recited in Claim 1, further comprising a first portion and a second portion, said first portion and said second portion separated by said line of weakness therebetween, and where said magnetic wafer seal will hold two sides of a folded piece together when said first portion is adhesively attached to a first outer surface of the folded piece, said magnetic wafer seal is folded along said line of weakness, and said second portion is adhesively attached to a second outer surface of the folded piece.
8. (Original) The magnetic wafer seal as recited in Claim 1, where when said magnetic wafer seal is broken along said line of weakness, thereby separating said first portion and said second portion, said magnetic wafer seal forms at least two magnetic holders.
9. (Original) The magnetic wafer seal as recited in Claim 1 where said line of weakness comprises a scoreline.
10. (Original) The magnetic wafer seal as recited in Claim 1 where said line of weakness comprises a multiplicity of adjacent slits, where each of said multiplicity of adjacent slits is separated by a spacing.
11. (Original) A magnetic wafer seal comprising:
 - a. a flexible magnet, said magnet having an upper surface, a lower surface, a thickness between said upper surface and said lower surface, and two intersecting lines of weakness extending at least partially across said upper

- surface, and a shape; and
- b. an adhesive layer affixed to said lower surface;
 - c. where said two lines of weakness extend at least partially through said thickness toward said lower surface, said flexible magnet being foldable along said line of weakness.
12. (Original) The magnetic wafer seal as recited in Claim 11, where said two lines of weakness are each comprised of a multiplicity of perforations, and where said multiplicity of perforations are separated by a spacing between adjacent perforations of said multiplicity of perforations.
13. (Original) The magnetic wafer seal as recited in Claim 12, where said spacing comprises a first spacing and a second spacing, said first spacing having a shorter length than said second spacing.
14. (Original) The magnetic wafer seal as recited in Claim 13, where said two lines of weakness are further comprised of at least two areas of weakness, said at least two areas of weakness each comprised of a multiplicity of perforations separated by a first spacing between adjacent perforations of said multiplicity of perforations, where adjacent said at least two areas of weakness are separated by a second spacing therebetween.
15. (Original) The magnetic wafer seal as recited in Claim 14, where said two lines of weakness extend substantially across said upper surface.
16. (Original) The magnetic wafer seal as recited in Claim 15, where said multiplicity of perforations extend fully through said thickness to said lower surface.
17. (Original) The magnetic wafer seal as recited in Claim 11, further comprising a first portion and a second portion, said first portion and said second portion separated by one of said two lines of weakness therebetween, and where said magnetic wafer seal will hold two sides of a folded piece together when said first portion is adhesively attached to a first outer surface of the folded piece, said magnetic wafer seal is folded along said one of said two lines of weakness, and said second portion is adhesively

attached to a second outer surface of the folded piece.

18. (Original) The magnetic wafer seal as recited in Claim 11, where when said magnetic wafer seal is broken along one of said two lines of weakness, thereby separating said first portion and said second portion, said magnetic wafer seal forms at least two magnetic holders.
19. (Original) The magnetic wafer seal as recited in Claim 11 where said two lines of weakness each comprise a scoreline.
20. (Original) The magnetic wafer seal as recited in Claim 11 where said two lines of weakness each comprise a multiplicity of adjacent slits, where each of said multiplicity of adjacent slits is separated by a spacing.